QuickSpecs

Overview

HP Elite x3

1. Power LED
2. Status bar
3. Back arrow

4. Speaker
5. Earpiece and speaker
6. 8 MP camera

7. Iris camera
8. Search
9. Home key

1. 16 MP camera
2. Flash

3. Fingerprint reader
   (Fingerprint reader will not be enabled until OTA update coming soon)
4. Pogo pins

Not all configuration components are available in all regions/countries.
QuickSpecs

Overview

1. Power button
2. Volume up
3. Volume down
4. Microphone

1. Nano SIM/micro SD Slot
QuickSpecs

Overview

1. 3.5mm combo headset/microphone jack

1. USB 3.0 Type-C™
At A Glance

- Built-for-business mobile device delivering seamless phablet, laptop and desktop business productivity in a single device
- Windows 10 Mobile
- Microsoft Continuum support
- Qualcomm® Snapdragon® 820 processor
- Indoor/outdoor, edge-to-edge display
  - 5.96" diagonal WQHD (2560 x 1440) AMOLED multitouch display
  - 494 PPI
  - Corning® Gorilla® Glass 4 and anti-smudge coating
- 4GB LPDDR4 memory
- 64GB internal storage
- Dual SIM Model; Single SIM Model
- Two color options: Graphite/Chrome; Gold/Gold ¹
- Passed MIL-STD 810G ²
- Passed IP67 ³
- Front-facing audio speakers tuned by Bang & Olufsen and noise canceling omni-directional mics
- 16 MP rear camera. 8 MP front-facing camera for video conferencing, photos, and more
- Dual biometric authentication with Iris camera and fingerprint reader, with ultimate security measure enabled by Qualcomm and Windows platforms.
- Optional HP Elite x3 Desk Dock
- Optional HP Elite x3 Lap Dock is designed as an ultra-slim, near borderless 12.5" diagonal display notebook form factor that connects with the HP Elite x3 to achieve a seamless Windows Continuum computing experience
- Standard commercial 1 year limited warranty with extended service available with optional HP Care Packs

NOTE: See important legal disclosures for all listed specs in their respective features sections.

¹ Gold/Gold color model is not available in all countries.

² MIL-STD 810G is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. MIL-STD 810G test results are not a guarantee of future performance under these test conditions. Damage under the MIL-STD 810G test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.

³ IP 67 tested. Test results are not a guarantee of future performance under these test conditions. Damage under the test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.
QuickSpecs

Technical Specifications

PRODUCT NAME
HP Elite x3

OPERATING SYSTEM
Preinstalled Windows 10 Mobile*

* Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 Mobile is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.

PROCESSOR*
Qualcomm® Snapdragon® 820 (2.15 GHz, 4 cores)*

* Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Qualcomm’s numbering is not a measurement of clock speed.

CHIPSET
Qualcomm® MSM8996

GRAPHICS
Qualcomm® Adreno 530 GPU (integrated in Qualcomm® Snapdragon 820 processor)

DISPLAY
5.96” diagonal WQHD AMOLED multitouch display (2560 x 1440)*
Type AMOLED multitouch display
Size 5.96” diagonal
Resolution WQHD (2560 x 1440)*
Multitouch Yes
Protection Corning® Gorilla® Glass 4 and anti-smudge coating
Brightness 350 nits (Typical)
Pixels Per Inch 494 PPI

* WQHD content required to view WQHD images.

STORAGE AND DRIVES
Internal Storage*
64 GB eMMC 5.1

*For storage, GB = 1 billion bytes. Actual formatted capacity is less. Up to 8 GB is reserved for system recovery software.
Expansion Storage
(1) microSD - supporting expansion up to 2TB*

* MicroSD shares the same slot with second SIM on Dual SIM Model. MicroSD cards sold separately. Supports up to 2TB capacity when this capacity becomes available.

MEMORY
4 GB LPDDR4 SDRAM (onboard)*

PORTS/SLOTS
Ports
1 USB 3.0 Type-C™
1 3.5 mm 3 and 4 pole headphone jack
Video out via USB 3.0 DP alt mode
Pogo pins

Slots
Configuration Options:

Dual SIM Model
- Dual Nano SIM
- or Nano SIM + microSD card

Single SIM Model*
- Nano SIM + microSD card

*Single SIM Model may not be available in some countries.

NETWORKING/COMMUNICATIONS

WWAN: 2G/3G/4G, LTE-A with carrier aggregation
- Supports up to CAT6

Wireless LAN (WLAN) 2
802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.0 LE combo; Miracast supported 3

Other: NFC (NQ210); Wireless Charging (Qi/PMA); Standalone and Assisted GPS

1 WWAN requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, and in all regions.
2 For all 802.11 wireless, wireless access point and Internet service is required and is not included. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

3 Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you’re doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast.

**AUDIO/MULTIMEDIA**

**Audio**
- 2 front-facing stereo speakers (one with earpiece)
- 3 integrated omni-directional microphones with Qualcomm Fluence™ Pro technology
- 1 external microphone (from headset jack)
- Snapdragon Audio+ support
- Audio by B&O PLAY

**Camera – Front**
- 8MP Front Facing Camera
  - 2x2 Binning for high quality FHD video conferencing
  - Record at FHD/30fps
  - Low light capabilities
  - 5P Japanese Lens f/2.2
  - 1.12um pixels – 16:9 Native Format – 3872x2192

**Camera – Back**
- 16MP Rear Facing Camera
  - Record 4K/30fps or FHD/30fps
  - Low light capabilities
  - 6P Japanese Lens f/2.2
  - High output, ultra-high CRI LED flash
  - PDAF (phase detection auto focus)*
  - Large 1.31um pixels – 4:3 Native Format – 4608x3456

* PDAF will not be enabled until OTA update coming soon

**SOFTWARE AND SECURITY**

Preinstalled Software with Windows 10 Mobile Operating System

**HP Value Add Software**
- HP Workspace*
- HP All-in-One Remote²
- HP Device Hub
- 12C calculator²

* HP Workspace subscription required. Corporate applications must be licensed on corporate network for virtualization. Requires the HP Elite x3 to be docked with the HP Elite x3 Desk Dock or connected to the HP Elite x3 Lap Dock, each sold separately or as part of a solution bundle.
QuickSpecs

**Technical Specifications**

**3rd Party**
Salesforce universal app

Winzip Universal

**Microsoft Products**
Word
Excel
PowerPoint
OneNote
OneDrive
Microsoft Edge
Continuum
Skype
Groove music
Cortana
Remote Desktop

**Manageability**
AirWatch (via MDM settings)
MobileIron (via MDM settings)
HP Touchpoint Manager (via MDM settings)

**Client Security Software**
VPN profile setup from settings menu

---

1 Salesforce web launcher app is a link to the salesforce.com website, but will be updated with Salesforce Universal application once available.
2 Available in future software update.
3 Available in future software update. Salesforce subscription required.
4 Skype is not offered in China.
5 Check link below for Cortana availability:
   http://windows.microsoft.com/en-us/windows-10/cortanas-regions-and-languages#v1h=tab01
6 Will need to be configured by user/IT manager.

**Security Features (Standard)**
- Dual biometrics with Iris recognition and Fingerprint reader *
- FIPS 140-2 cryptography
- Qualcomm processor includes Secure Boot, 128-bit key Unified Image Encryption, 256-bit key Full Disk Encryption, Anti roll back and fTPM 2.0 security
- Windows 10 Mobile includes 128 key Bitlocker encryption and Enterprise grade VPN

* Fingerprint reader will not be enabled until OTA update coming soon.
QuickSpecs

Technical Specifications

POWER

**Power Supply**
10 W 5V/2A adapter

**Battery**
4150 mAh Li-ion polymer

**Battery Life**
Standby up to 500 hours*
Talk up to 33 hours*
Web up to 14 hours*

*Actual battery times will vary depending on the network conditions, settings, configuration, individual usage pattern and other conditions. Use of wireless and backlight will significantly decrease battery run time. Maximum capacity will naturally decrease with time and usage.

Video Playback up to 13 hours*

*Tested by HP using 720p (1280x720), video media file, single SIM, 200 nits brightness, airplane mode on, volume level at 50% with wired headset inserted. Actual battery life will vary depending on configuration and maximum capacity will naturally decrease with time and usage.

WEIGHTS & DIMENSIONS

**Weight**
Starting at 194 g (0.4277 lb)
Weight will vary by configuration.

**Dimensions** (portrait orientation)*

83.5 x 161.8 x 7.8 mm (3.29 x 6.36 x 0.31 in)

SENSORS

ALS (Ambient Light Sensor) + Proximity Combo
Accelerometer + Gyro
Pressure
Hall Effect
NFC (NQ210)
Standalone and Assisted GPS
eCompass
QuickSpecs

Technical Specifications

COLOR

Graphite/Chrome
Gold/Gold

*Gold/Gold color model not available in all countries.

TESTING

Passed IP 67, providing seals against liquid and dust ingress to IP 67 rating.*
Passed MIL-STD 810G testing.**

*IP 67 tested. Test results are not a guarantee of future performance under these test conditions. Damage under the test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.
**MIL STD 810G testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.

WHAT'S IN THE BOX?

HP Elite x3, 10W power adapter, USB Type-C™ to USB Type A cable, documentation*

*Varies by configuration bundle.

SERVICE AND SUPPORT

HP Services offers a 1-year limited warranty. Internal batteries have the same 1-year limited warranty as the platform. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.

SYSTEM UNIT

<table>
<thead>
<tr>
<th>Stand-Alone Power Requirements (AC Power)</th>
<th>Nominal Operating Voltage</th>
<th>Average Operating Power</th>
<th>Max Operating Power</th>
</tr>
</thead>
<tbody>
<tr>
<td>5 V (9V max)</td>
<td>1.2 W</td>
<td>&lt; 15 W</td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Temperature</th>
<th>Operating</th>
<th>14° to 131° F (-10° to 55° C)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Non-operating</td>
<td>-4° to 140° F (-20° to 60° C)</td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Relative Humidity</th>
<th>Operating</th>
<th>10% to 90%, non-condensing</th>
</tr>
</thead>
<tbody>
<tr>
<td>Non-operating</td>
<td>5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature</td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Shock</th>
<th>Operating</th>
<th>40 G, 2 ms, half-sine</th>
</tr>
</thead>
<tbody>
<tr>
<td>Random Vibration</td>
<td>Operating</td>
<td>1.043 grms</td>
</tr>
<tr>
<td>Non-operating</td>
<td>Non-operating</td>
<td>3.50 grms</td>
</tr>
<tr>
<td>Altitude (unpressurized)</td>
<td>Operating</td>
<td>-50 to 10,000 ft (-15.24 to 3,048 m)</td>
</tr>
<tr>
<td></td>
<td>Non-operating</td>
<td>-50 to 40,000 ft (-15.24 to 12,192 m)</td>
</tr>
</tbody>
</table>
NETWORKING/COMMUNICATIONS

HP Elite x3 is a high end mobile device based on Qualcomm® Snapdragon 820 processor. It supports the following wireless technologies and protocols.

**WWAN**

**Technology/Operating bands**

**WCDMA/HSDPA/HSUPA/HSPA+:** 2100 (Band I), 1900 (Band II), AWS (Band IV), 850 (Band V), 900 (Band VIII) MHz

**GSM/GPRS/EDGE:** 1900 MHz (Band II), 1800 MHz (Band III), 850 MHz (Band V), 900 MHz (Band VIII) MHz

**EMEA+APJ model**

- 2G: 850/900/1800/1900 MHz
- 3G: B5/8/2/1/4
- 2DL CA: B3+B20, B3+B7, B20+B7, B7+B28, B1+B3, B3+B5, B3+B8, B3+B19, B3+B26, B1+B5, B1+B19, B1+B26, B3+B28, B1+B41, TDD Intra CA

**LTE:**

FDD 2000 (B1), 1800 (B3), 850 (B5), 2600 (B7), 900 (B8), 800U (B19), 800DD (B20), 850+ (B26), 700APT (B28); TDD 2600 (B38), 1900 (B39), 2300 (B40), 2500 (B41)

2DL CA -- B3+B20, B3+B7, B20+B7, B7+B28, B1+B3, B3+B5, B3+B8, B3+B19, B3+B26, B1+B5, B1+B19, B1+B26, B3+B28, B1+B41, TDD Intra CA

**Americas model**

- 2G: 850/900/1800/1900 MHz
- 3G: B5/8/2/1/4

**LTE:**

1900 (B2), AWS (B4), 850 (B5), 2600 (B7), 700A (B12), 700B (B17), 700D (B29), 2300 (B30)


**Other**

No CDMA 1X and EVDO, No SVLTE, No TD-SCDMA

**Wireless protocol standards**

GSM/GPRS/EDGE: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9.

UMTS/WCDMA/HSPA+: Release 99 and Release 8

LTE CAT6

Advanced Receiver Type 3i

**Maximum Data Rates:**

- HSPA+: UL 5.76 Mbps / DL 21.6 Mbps
- HSPA: UL 5.76 Mbps / DL 7.2 Mbps
- WCDMA PS: UL 384 kbps / DL 384 kbps
- WCDMA CS: UL 64 kbps / DL 64 kbps
- GPRS: UL 85.6 kbps / DL 107 kbps
- EDGE: UL 236.8 kbps / DL 296 kbps
- LTE CAT 6: UL 50 Mbps / 300 Mbps

HP Elite x3 follows 3GPP definitions for each technology and standard. Actual data rate will vary due to the location, environment, network conditions, available bands, and other factors.
QuickSpecs

Technical Specifications

Maximum output power
- WCDMA/HSPA/HSPA+: 24 dBm
- GPRS 1900/1800 MHz: 30 dBm
- GPRS 900/850 MHz: 33 dBm
- EDGE 1900/1800 MHz: 26 dBm
- EDGE 900/850 MHz: 27 dBm
- LTE: 23 dBm

Connectivity
Supporting WLAN 802.11 a/b/g/n/ac dual bands; 2x2 MIMO for 11ac; Supporting Miracast/Wi-Fi Direct mirroring. Supporting Bluetooth Class 2, Bluetooth 4.0 LE and security

GPS
Standalone, A-GPS, GLONASS, Beidou

GPS Bands:
- GPS 1575.42 MHz ± 1.023 MHz, GLONASS 1593-1610MHz; Beidou 1561.098MHz/1589.742MHz

NFC
Supporting peer to peer and R/W modes for type A, B, and F standards and tags type 1, 2, 3, and 4.

Wireless Charging
HP Elite x3 implements with WPC(Qi)/PMA dual mode wireless charging feature; supporting 5W and foreign object detection for Qi v1.1 and PMA compliance.

*WWAN requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, and in all regions

POWER

HP Single-cell Polymer Battery (15.98 WHr)

<table>
<thead>
<tr>
<th>Cells/Type</th>
<th>1-cell Lithium-Ion Polymer</th>
</tr>
</thead>
<tbody>
<tr>
<td>Amp-hour capacity</td>
<td>4150 mAh</td>
</tr>
<tr>
<td>Watt-hour capacity</td>
<td>15.98 WHr</td>
</tr>
<tr>
<td>Battery recharge time</td>
<td>System in OFF or Standby Mode &lt;3 hours</td>
</tr>
</tbody>
</table>

MIL-STD 810G TEST

Drop*
The drop test was performed in accordance with MIL-STD-810G, Method 516.6, Procedure IV. The objective of this test was to determine whether the unit was operational after being dropped from desk height. For this test, 26 drops were performed from 4 ft onto every side, angle and edge onto 2” of plywood over steel over concrete.

High Temperature test*
The High Temperature test was performed in accordance with MIL-STD-810G, Method 501.5, Procedure I (Storage). This test evaluated the units’ performance while it was being exposed to high temperature conditions: 71°C (160°F) nonoperational. Test cycle 24 hours; test consisted of seven cycles.

High Temperature test*
The High Temperature test was performed in accordance with MIL-STD-810G, Method 501.5, Procedure II (Operation). This test evaluated the units’ performance while it was being exposed to high temperature conditions: 60°C (140°F) operational. Four hours duration.
QuickSpecs

Technical Specifications

**Low Temperature test**
The Low Temperature test was performed in accordance with MIL-STD-810G, Method 502.5, Procedure I (Storage). This test evaluated the unit’s performance while it was being exposed to low temperature conditions: -51°C (-60°F) nonoperational. Four hours duration.

**Low Temperature test**
The Low Temperature test was performed in accordance with MIL-STD-810G, Method 502.5, Procedure II (Operation). This test evaluated the unit’s performance while it was being exposed to low temperature conditions: -29°C (20°F) operational. Four hour duration.

**Thermal Shock test**
The Thermal Shock test was performed in accordance with MILSTD-810G, Method 503.5, Procedure I. The objective of this test was to determine whether the unit could be safely operated after being exposed to sudden changes in ambient temperature while non-operational. The high temperature was set to be 96°C (205°F) and the low temperature to be -51°C (-60°F); three high-to-low cycles were performed.

**Altitude**
The Altitude test was performed in accordance with MIL-STD-810G, Method 500.5, Procedure I (Storage) and II (Operation). The altitude level simulated for both procedures was 15,000 feet at 57kPa. Four hour duration.

**Humidity**
The humidity test was performed in accordance with MIL-STD-810G, Method 507.5, Procedure II. Relative humidity 95%. Temperature cycled between 86°F and 140°F. Test cycle 24 hours; test consisted of ten cycles.

**Dust**
The dust test was performed in accordance with MIL-STD-810G, Method 510.5, Procedure I. Test parameters were set so that the unit was dusted with Arizona Road Dust for six hours while being operated. Each cycle was one day (24 hours); ten cycles with the temperature being cycled between 30°C (86°F) and 60°C (140°F); and relative humidity was a constant 95%.

**Vibration**
The vibration test was performed in accordance with MIL-STD-810G, Method 514.6, Procedure I category 4. This test evaluated the unit’s performance after it has been subjected to higher levels of vibration while in storage: Operational U.S. highway truck exposure, 1000 mile Simulation and One hour/axis duration.

**Vibration 2**
The vibration test was performed in accordance with MIL-STD-810G, Method 514.6, Procedure I category 24. This test evaluated the unit’s performance after it has been subjected to higher levels of vibration while in storage: Non-operational 0.04 g2/Hz at 20-1000 Hz, -6 dB/octave at 1000-2000 Hz and One hour/axis duration.

**Shock**
The shock test was performed in accordance with MIL-STD-810G, Method 516.6, Procedure I. This test objective was to determine whether the unit could be safely operated after being exposed to sudden physical shock events while operational. For this test, 3 shocks were performed across each axis and direction for a total of 18 shocks -40Gs peak, 11ms.

**Freeze/Thaw test**
The Freeze/Thaw test was performed in accordance with MILSTD-810G, Method 524.54 Procedure III. The objective of this test was to determine whether the unit could be safely operated after being exposed to a temperature drop of -10°C (14°F) for two hours. Unit is removed and checked for operation.

**Sand test**
The Sand test was performed in accordance with MIL-STD-810G, Method 510.5 Procedure II

**Explosive Atmosphere**
The Explosive Atmosphere test was performed in accordance with MIL-STD 810G, Method 511.5 Procedure I.

*MIL STD 810G testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.*
COUNTRY OF ORIGIN

China
## PRODUCT AVAILBLITY BY REGION

<table>
<thead>
<tr>
<th>Region</th>
<th>Country/Area</th>
<th>Region</th>
<th>Country/Area</th>
</tr>
</thead>
<tbody>
<tr>
<td>AMS</td>
<td>Canada</td>
<td>EMEA</td>
<td>Austria</td>
</tr>
<tr>
<td></td>
<td>Chile</td>
<td></td>
<td>Belgium</td>
</tr>
<tr>
<td></td>
<td>Colombia</td>
<td></td>
<td>Czech Republic</td>
</tr>
<tr>
<td></td>
<td>Mexico</td>
<td></td>
<td>Slovakia</td>
</tr>
<tr>
<td></td>
<td>US</td>
<td></td>
<td>France</td>
</tr>
<tr>
<td></td>
<td>Ecuador</td>
<td></td>
<td>Germany</td>
</tr>
<tr>
<td></td>
<td>Peru</td>
<td></td>
<td>Greece</td>
</tr>
<tr>
<td></td>
<td>Panama</td>
<td></td>
<td>Hungary</td>
</tr>
<tr>
<td></td>
<td>Puerto Rico</td>
<td></td>
<td>Ireland</td>
</tr>
<tr>
<td></td>
<td>Costa Rica</td>
<td></td>
<td>Italy</td>
</tr>
<tr>
<td>APJ</td>
<td>Australia</td>
<td></td>
<td>Luxembourg</td>
</tr>
<tr>
<td></td>
<td>New Zealand</td>
<td></td>
<td>Netherlands</td>
</tr>
<tr>
<td></td>
<td>Malaysia</td>
<td></td>
<td>Denmark</td>
</tr>
<tr>
<td></td>
<td>Philippines</td>
<td></td>
<td>Norway</td>
</tr>
<tr>
<td></td>
<td>Singapore</td>
<td></td>
<td>Sweden</td>
</tr>
<tr>
<td></td>
<td>Thailand</td>
<td></td>
<td>Finland</td>
</tr>
<tr>
<td></td>
<td>Taiwan</td>
<td></td>
<td>Poland</td>
</tr>
<tr>
<td></td>
<td>Hong Kong</td>
<td></td>
<td>Portugal</td>
</tr>
<tr>
<td></td>
<td>India</td>
<td></td>
<td>Romania</td>
</tr>
<tr>
<td></td>
<td>Japan</td>
<td></td>
<td>Russia</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Saudi Arabia</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>South Africa</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Spain</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Switzerland</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Turkey</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>United Arab Emirates</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>United Kingdom</td>
</tr>
</tbody>
</table>
## Options and Accessories (sold separately and availability may vary by country)

<table>
<thead>
<tr>
<th>Type</th>
<th>Description</th>
<th>Part number</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Docking</strong></td>
<td>HP Elite x3 Lap Dock</td>
<td>Y4T08AA</td>
</tr>
<tr>
<td></td>
<td>HP Elite x3 Desk Dock</td>
<td>V5H01AA</td>
</tr>
<tr>
<td><strong>Cases</strong></td>
<td>HP Elite x3 Rugged Case</td>
<td>V8Z63AA</td>
</tr>
<tr>
<td></td>
<td>HP Elite x3 Silicone Case</td>
<td>V8Z62AA</td>
</tr>
<tr>
<td></td>
<td>HP Elite x3 Wallet Folio Leather Case</td>
<td>V8Z61AA</td>
</tr>
<tr>
<td><strong>Screen Protectors</strong></td>
<td>HP Elite x3 Anti-Fingerprint Screen Protector (3-pack)</td>
<td>W8W95AA</td>
</tr>
<tr>
<td></td>
<td>HP Elite x3 Anti-Shatter Glass Screen Protector (1-pack)</td>
<td>W8W94AA</td>
</tr>
<tr>
<td></td>
<td>HP Elite x3 Privacy Screen (1-pack)</td>
<td>W8W96AA</td>
</tr>
<tr>
<td><strong>Adapters</strong></td>
<td>HP USB-C to VGA Adapter</td>
<td>N9K76AA</td>
</tr>
<tr>
<td></td>
<td>HP USB-C to USB-A Adapter</td>
<td>N2Z63AA</td>
</tr>
<tr>
<td><strong>Power/Charging</strong></td>
<td>HP Elite x3 Wireless Charger</td>
<td>W9A82AA</td>
</tr>
<tr>
<td></td>
<td>HP 12W USB Auto Power Adapter</td>
<td>G4H12AA</td>
</tr>
<tr>
<td></td>
<td>HP 15W USB-C AC Adapter</td>
<td>N4G74AA</td>
</tr>
<tr>
<td><strong>Multimedia</strong></td>
<td>HP UC Wireless Duo Headset</td>
<td>W3K09AA</td>
</tr>
<tr>
<td></td>
<td>HP UC Wireless Mono Headset</td>
<td>W3K08AA</td>
</tr>
<tr>
<td><strong>Others</strong></td>
<td>HP Tablet Cleaning Kit</td>
<td>K6F99AA</td>
</tr>
</tbody>
</table>
QuickSpecs

© Copyright 2016 HP Development Company, L.P. All rights reserved.

The information contained herein is subject to change without notice. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein. Microsoft and Windows are registered trademarks or trademarks of Microsoft Corporation in the U.S. and/or other countries. Intel, Core and vPro are trademarks of Intel Corporation in the U.S. and/or other countries. Bluetooth is a trademark of its proprietor, used by Hewlett-Packard Company under license. USB Type-C™ and USB-C™ are trademarks of USB Implementers Forum. ENERGY STAR is a registered trademark owned by the U.S. Environmental Protection Agency.

Not all configuration components are available in all regions/countries.

© Copyright 2016 HP Development Company, L.P. All rights reserved.

The information contained herein is subject to change without notice. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein. Microsoft and Windows are registered trademarks or trademarks of Microsoft Corporation in the U.S. and/or other countries. Intel, Core and vPro are trademarks of Intel Corporation in the U.S. and/or other countries. Bluetooth is a trademark of its proprietor, used by Hewlett-Packard Company under license. USB Type-C™ and USB-C™ are trademarks of USB Implementers Forum. ENERGY STAR is a registered trademark owned by the U.S. Environmental Protection Agency.
## Summary of Changes

<table>
<thead>
<tr>
<th>Date of change:</th>
<th>Version History:</th>
<th>Description of change:</th>
</tr>
</thead>
<tbody>
<tr>
<td>July 1, 2016</td>
<td>From v1 to v2</td>
<td>Adding battery life specification.</td>
</tr>
<tr>
<td>July 5, 2016</td>
<td>From v2 to v3</td>
<td>Updated Battery life time</td>
</tr>
<tr>
<td>July 11, 2016</td>
<td>From v3 to v4</td>
<td>Removed Skype for Business from Software section</td>
</tr>
<tr>
<td>July 17, 2016</td>
<td>From v4 to v5</td>
<td>Multiple edits</td>
</tr>
<tr>
<td>August 24, 2016</td>
<td>V7</td>
<td>Addition to Workplace disclaimer</td>
</tr>
</tbody>
</table>